

STP120NF04

N-channel 40V - 0.0047Ω - 120A TO-220 STripFET™ II MOSFET

General features

Туре	V _{DSS}	R _{DS(on)}	I _D	Pw
STP120NF04	40V	<0.0050Ω	120A	300W

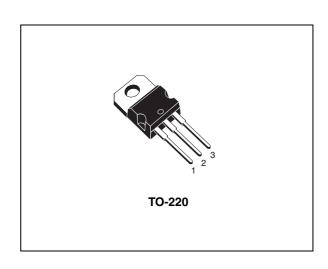
- Standard threshold drive
- 100% avalanche tested

Description

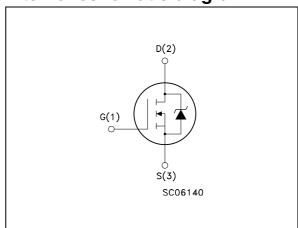
This MOSFET is the latest development of STMicroelectronics unique "Single Feature Size™" strip-based process. The resulting transistor shows extremely high packing density for low on-resistance, rugged avalanche characteristics and less critical alignment steps therefore a remarkable manufacturing reproducibility.

Applications

Switching application



Internal schematic diagram



Order codes

Part number	Marking	Package	Packaging	
STP120NF04	P120NF04	TO-220	Tube	

Contents STP120NF04

Contents

1	Electrical ratings 3
2	Electrical characteristics 4
	2.1 Electrical characteristics (curves)
3	Test circuit
4	Package mechanical data11
5	Revision history13

STP120NF04 Electrical ratings

1 Electrical ratings

Table 1. Absolute maximum ratings

Symbol	Parameter	Value	Unit
V _{DS}	Drain-source voltage (V _{GS} = 0)	40	V
V _{GS}	Gate-source voltage	± 20	٧
I _D ⁽¹⁾	Drain current (continuous) at T _C = 25°C	120	Α
I _D	Drain current (continuous) at T _C = 100°C	120	Α
I _{DM} ⁽²⁾	Drain current (pulsed)	480	Α
P _{TOT}	Total dissipation at T _C = 25°C	300	W
	Derating factor	2	W/°C
dv/dt ⁽³⁾	Peak diode recovery voltage slope	6	V/ns
E _{AS} ⁽⁴⁾	Single pulse avalanche energy	1.2	J
T _J T _{stg}	Operating junction temperature Storage temperature -55 to 175		°C

- 1. Current Limited by Package
- 2. Pulse width limited by safe operating area
- 3. $I_{SD} \leq 20A$, di/dt $\leq 300A/\mu s$, $V_{DD} \leq V_{(BR)DSS}$, $T_j \leq T_{JMAX}$.
- 4. Starting $T_j = 25$ °C, $I_d = 60$ A, $V_{DD} = 30$ V

Table 2. Thermal data

R _{thj-case}	Thermal resistance junction-case Max	0.5	°C/W
Rthj-pcb	Thermal resistance junction-pcb Max	see Figure 14. on page 8	°C/W
R _{thj-a}	Thermal resistance junction-ambient (free air) Max	62.5	°C/W
T _I	Maximum lead temperature for soldering purpose	300	°C

Electrical characteristics STP120NF04

2 Electrical characteristics

(T_{CASE} =25°C unless otherwise specified)

Table 3. On/off states

Symbol	Parameter	er Test conditions		Тур.	Max.	Unit
V _{(BR)DSS}	Drain-source breakdown voltage	$I_D = 250 \ \mu A, \ V_{GS} = 0$	40			٧
I _{DSS}	Zero gate voltage drain current (V _{GS} = 0)	V_{DS} = Max Rating V_{DS} = Max Rating, T_{C} = 125 °C			1 10	μΑ μΑ
I _{GSS}	Gate body leakage current (V _{DS} = 0)	V _{GS} = ± 20V			±100	nA
V _{GS(th)}	Gate threshold voltage	$V_{DS} = V_{GS}, I_{D} = 250 \mu A$	2.8		4.5	V
R _{DS(on)}	Static drain-source on resistance	$V_{GS} = 10V, I_D = 50 A$		0.0047	0.0050	Ω

Table 4. Dynamic

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
9 _{fs} ⁽¹⁾	Forward transconductance	V _{DS} =15V, I _D = 50A		150		S
C _{iss} C _{oss} C _{rss}	Input capacitance Output capacitance Reverse transfer capacitance	V _{DS} =25V, f=1 MHz, V _{GS} =0		5100 1300 160		pF pF pF
t _{d(on)} t _r	Turn-on delay time rise time	$V_{DD} = 20 \text{ V}, I_D = 60 \text{ A},$ $R_G = 4.7 \Omega, V_{GS} = 10 \text{ V}$ (see Figure 18)		35 220		ns ns
t _{d(off)}	Turn-off delay time fall time	$V_{DD} = 20 \text{ V}, I_D = 60 \text{ A},$ $R_G = 4.7 \Omega, V_{GS} = 10 \text{ V}$ (see Figure 18)		80 50		ns ns
Q _g Q _{gs} Q _{gd}	Total gate charge Gate-source charge Gate-drain charge	V_{DD} =32V, I_D = 120A V_{GS} =10V (see Figure 19)		110 35 35	150	nC nC nC

^{1.} Pulsed: pulse duration=300µs, duty cycle 1.5%

Table 5. Source drain diode

Symbol	Parameter	Test conditions	Min	Тур.	Max	Unit
I _{SD}	Source-drain current				120	Α
I _{SDM} ⁽¹⁾	Source-drain current (pulsed)				480	Α
V _{SD} ⁽²⁾	Forward on voltage	I _{SD} =120A, V _{GS} =0			1.3	V
t _{rr} Q _{rr} I _{RRM}	Reverse recovery time Reverse recovery charge Reverse recovery current	I _{SD} =120A, di/dt = 100A/μs, V _{DD} =20V, Tj=150°C (see Figure 20)		75 185 5		ns nC A

^{1.} Pulse width limited by safe operating area

^{2.} Pulsed: pulse duration=300µs, duty cycle 1.5%

Electrical characteristics STP120NF04

2.1 Electrical characteristics (curves)

Figure 1. Safe operating area

Figure 2. Thermal impedance

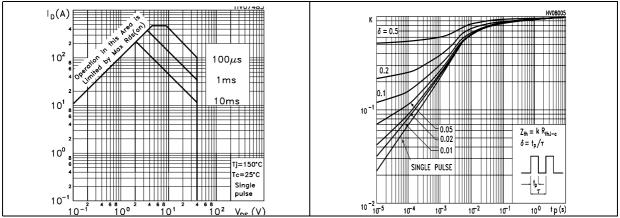


Figure 3. Output characterisics

Figure 4. Transfer characteristics

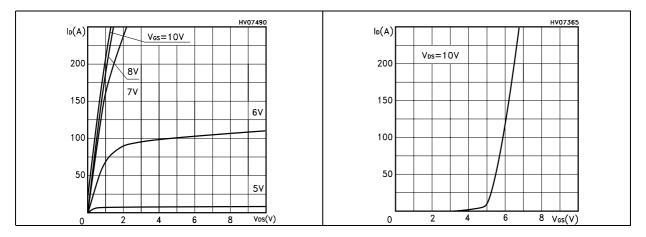
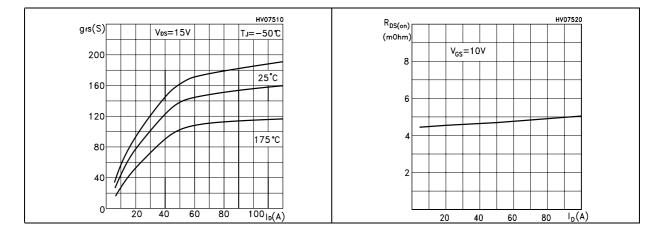


Figure 5. Transconductance

Figure 6. Static drain-source on resistance



6/14

Figure 7. Gate charge vs gate-source voltage Figure 8. Capacitance variation

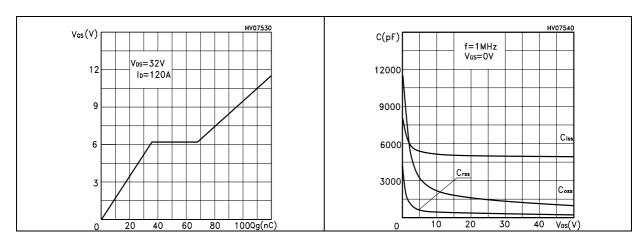


Figure 9. Normalized gate threshold voltage Figure 10. Normalized B_{VDSS} vs temperature vs temperature

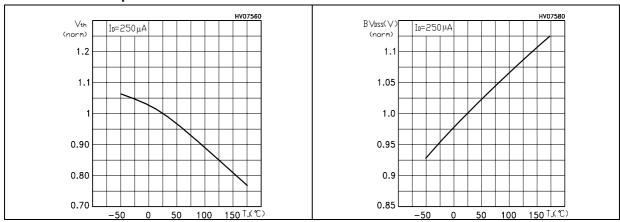
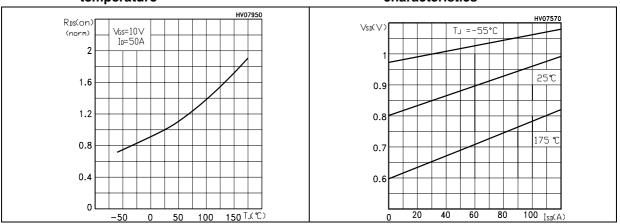


Figure 11. Normalized on resistance vs temperature

Figure 12. Source-drain diode forward characteristics

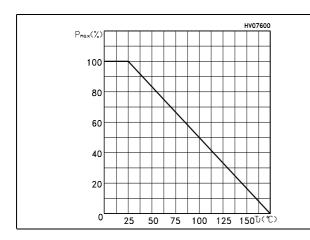


577

Electrical characteristics STP120NF04

Figure 13. Power derating vs Tc

Figure 14. Thermal resistance Rthj-a vs PCB copper area



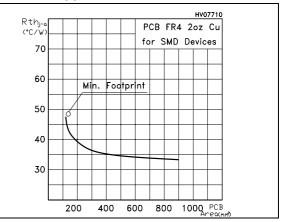
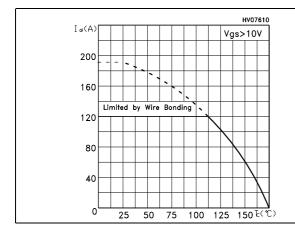
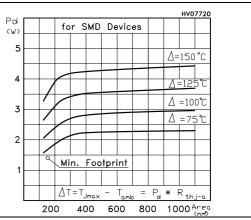


Figure 15. Max id current vs Tc

Figure 16. Max power dissipation vs PCB copper area





HYORO15

SINGLE PULSE

0.01

0.02

0.1

0.2

Figure 17. Allowable lav vs time in avalanche

The previous curve gives the safe operating area for unclamped inductive loads, single pulse or repetitive, under the following conditions:

$$P_{D(AVE)} = 0.5*(1.3*BV_{DSS}*I_{AV})$$

$$E_{AS(AR)} = P_{D(AVE)} * t_{AV}$$

Where:

I_{AV} is the allowable current in avalanche

P_{D(AVE)} is the average power dissipation in avalanche (single pulse)

t_{AV} is the time in avalanche

To derate above 25 $^{\circ}$ C, at fixed I_{AV}, the following equation must be applied:

$$I_{AV} = 2 * (T_{jmax} - T_{CASE}) / (1.3 * BV_{DSS} * Z_{th})$$

Where:

 Z_{th} = K * R_{th} is the value coming from Normalized Thermal Response at fixed pulse width equal to T_{AV} .

Test circuit STP120NF04

3 Test circuit

Figure 18. Switching times test circuit for resistive load

Figure 19. Gate charge test circuit

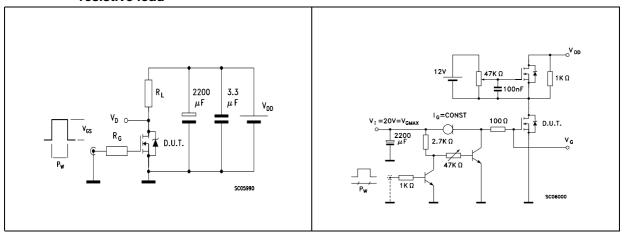


Figure 20. Test circuit for inductive load switching and diode recovery times

Figure 21. Unclamped Inductive load test circuit

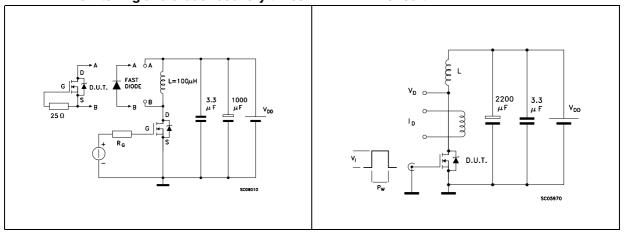
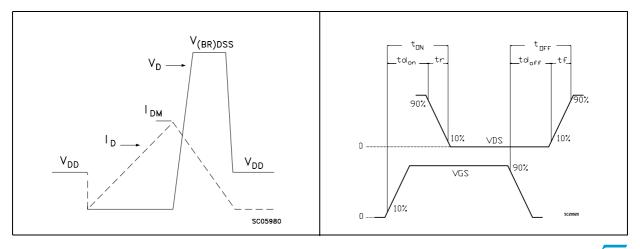


Figure 22. Unclamped inductive waveform

Figure 23. Switching time waveform



47/

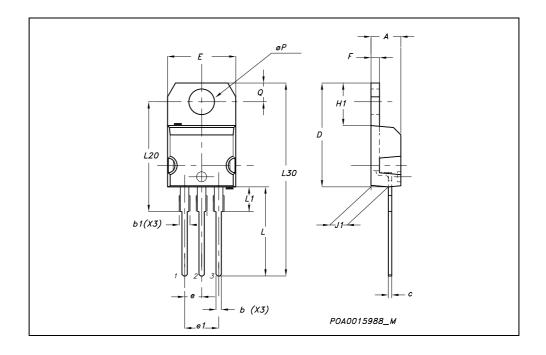
4 Package mechanical data

In order to meet environmental requirements, ST offers these devices in ECOPACK® packages. These packages have a Lead-free second level interconnect . The category of second level interconnect is marked on the package and on the inner box label, in compliance with JEDEC Standard JESD97. The maximum ratings related to soldering conditions are also marked on the inner box label. ECOPACK is an ST trademark. ECOPACK specifications are available at: www.st.com

11/14

TO-220 MECHANICAL DATA

DIM.	mm.				inch	
DIM.	MIN.	TYP	MAX.	MIN.	TYP.	MAX.
Α	4.40		4.60	0.173		0.181
b	0.61		0.88	0.024		0.034
b1	1.15		1.70	0.045		0.066
С	0.49		0.70	0.019		0.027
D	15.25		15.75	0.60		0.620
E	10		10.40	0.393		0.409
е	2.40		2.70	0.094		0.106
e1	4.95		5.15	0.194		0.202
F	1.23		1.32	0.048		0.052
H1	6.20		6.60	0.244		0.256
J1	2.40		2.72	0.094		0.107
L	13		14	0.511		0.551
L1	3.50		3.93	0.137		0.154
L20		16.40			0.645	
L30		28.90			1.137	
øΡ	3.75		3.85	0.147		0.151
Q	2.65		2.95	0.104		0.116



STP120NF04 Revision history

5 Revision history

Table 6. Revision history

Date	Revision	Changes
28-Feb-2005	1	First release.
02-Oct-2006	2	New template, no content change

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577